

PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Bag
Pitch - Mating Interface	4.20mm
Pitch - Termination Interface	4.20mm
Plating min - Mating	2.540μm
Plating min - Termination	2.540μm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	9.0A
Voltage - Maximum	600V

Solder Process Data

Duration at Max. Process Temperature (seconds)	005
Lead-free Process Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	240

Material Info

Engineering Number	5566-10AS
--------------------	-----------

Reference - Drawing Numbers

Packaging Specification	PK-5566-003-001
Product Specification	PS-5556-001-001
Sales Drawing	SD-5566-002-000

This document was generated on 10/10/2019

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Molex:](#)

[39-30-6101](#)